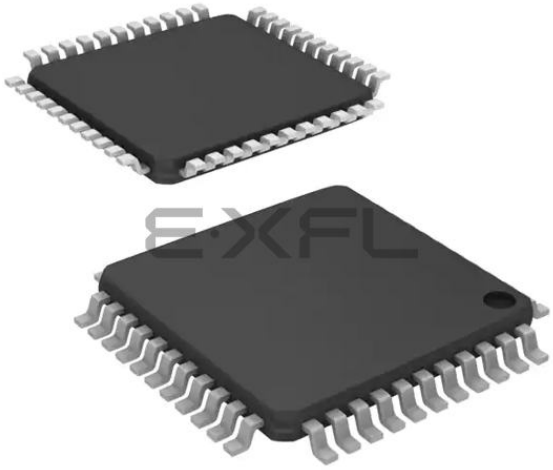

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Details	
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Speed	32MHz
Connectivity	I²C, IrDA, LINbus, SPI, UART/USART
Peripherals	Brown-out Detect/Reset, LVD, POR, PWM, WDT
Number of I/O	38
Program Memory Size	16KB (5.5K x 24)
Program Memory Type	FLASH
EEPROM Size	512 x 8
RAM Size	1K x 8
Voltage - Supply (Vcc/Vdd)	1.8V ~ 3.6V
Data Converters	A/D 22x10b/12b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 125°C (TA)
Mounting Type	Surface Mount
Package / Case	44-TQFP
Supplier Device Package	44-TQFP (10x10)
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/pic24f16km104-e-pt

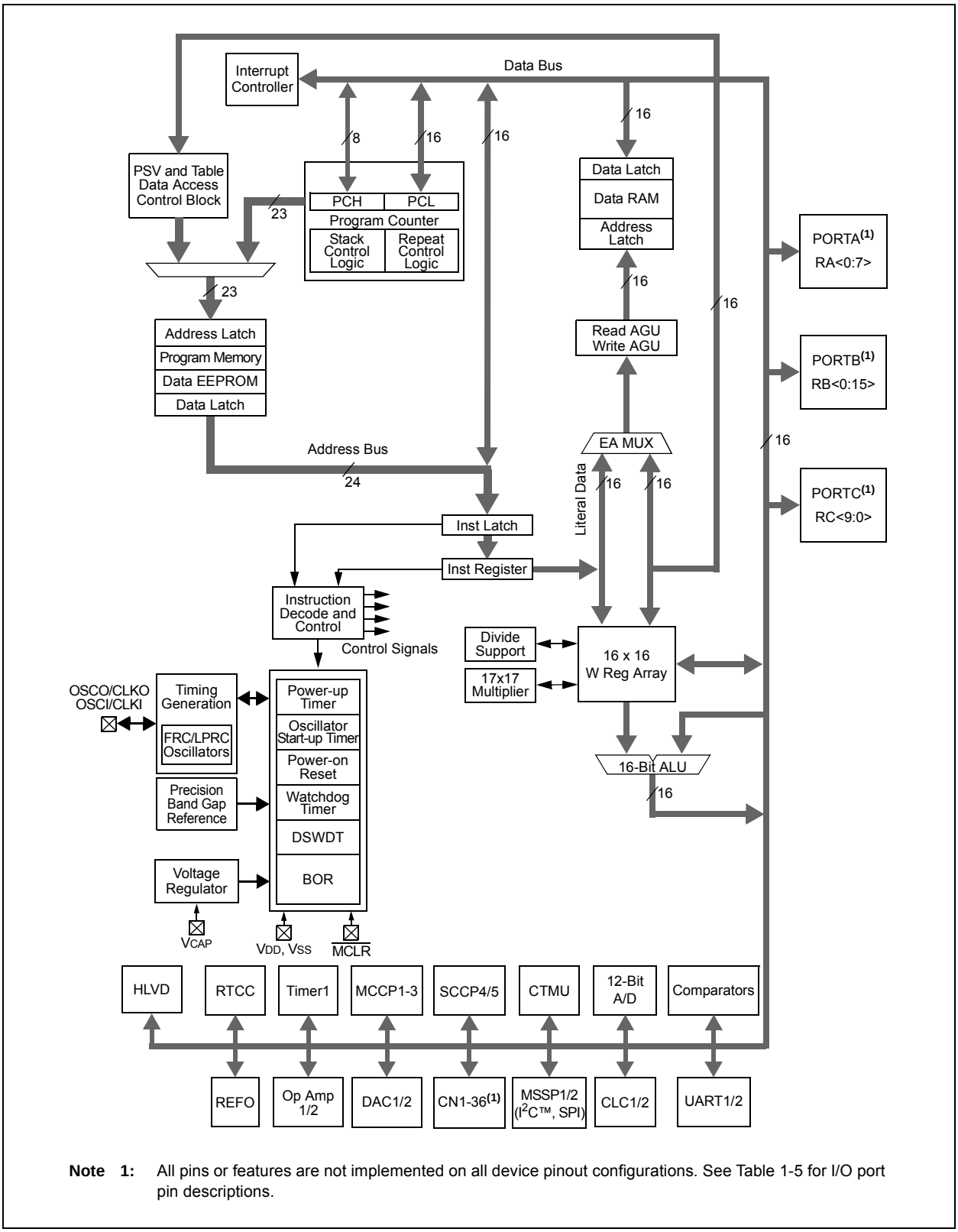
TABLE 1-1: DEVICE FEATURES FOR THE PIC24F16KM204 FAMILY

Features	PIC24F16KM204	PIC24F08KM204	PIC24F16KM202	PIC24F08KM202
Operating Frequency	DC-32 MHz			
Program Memory (bytes)	16K	8K	16K	8K
Program Memory (instructions)	5632	2816	5632	2816
Data Memory (bytes)	2048			
Data EEPROM Memory (bytes)	512			
Interrupt Sources (soft vectors/NMI traps)	40 (36/4)			
Voltage Range	1.8-3.6V			
I/O Ports	PORTA<11:0> PORTB<15:0> PORTC<9:0>		PORTA<7:0> PORTB<15:0>	
Total I/O Pins	38		24	
Timers	11 (One 16-bit timer, five MCCPs/SCCPs with up to two 16/32 timers each)			
Capture/Compare/PWM modules MCCP SCCP	 3 2			
Serial Communications MSSP UART	 2 2			
Input Change Notification Interrupt	37		23	
12-Bit Analog-to-Digital Module (input channels)	22	22	19	19
Analog Comparators	3			
8-Bit Digital-to-Analog Converters	2			
Operational Amplifiers	2			
Charge Time Measurement Unit (CTMU)	Yes			
Real-Time Clock and Calendar (RTCC)	Yes			
Configurable Logic Cell (CLC)	2			
Resets (and delays)	POR, BOR, RESET Instruction, $\overline{\text{MCLR}}$, WDT, Illegal Opcode, REPEAT Instruction, Hardware Traps, Configuration Word Mismatch (PWRT, OST, PLL Lock)			
Instruction Set	76 Base Instructions, Multiple Addressing Mode Variations			
Packages	44-Pin QFN/TQFP, 48-Pin UQFN		28-Pin SPDIP/SSOP/SOIC/QFN	

TABLE 1-3: DEVICE FEATURES FOR THE PIC24FV16KM204 FAMILY

Features	PIC24FV16KM204	PIC24FV08KM204	PIC24FV16KM202	PIC24FV08KM202
Operating Frequency	DC-32 MHz			
Program Memory (bytes)	16K	8K	16K	8K
Program Memory (instructions)	5632	2816	5632	2816
Data Memory (bytes)	2048			
Data EEPROM Memory (bytes)	512			
Interrupt Sources (soft vectors/NMI traps)	40 (36/4)			
Voltage Range	2.0-5.5V			
I/O Ports	PORTA<11:7,5:0> PORTB<15:0> PORTC<9:0>		PORTA<7,5:0> PORTB<15:0>	
Total I/O Pins	37		23	
Timers	11 (One 16-bit timer, five MCCPs/SCCPs with up to two 16/32 timers each)			
Capture/Compare/PWM modules MCCP SCCP	 3 2			
Serial Communications MSSP UART	 2 2			
Input Change Notification Interrupt	36		22	
12-Bit Analog-to-Digital Module (input channels)	22		19	
Analog Comparators	3			
8-Bit Digital-to-Analog Converters	2			
Operational Amplifiers	2			
Charge Time Measurement Unit (CTMU)	Yes			
Real-Time Clock and Calendar (RTCC)	Yes			
Configurable Logic Cell (CLC)	2			
Resets (and delays)	POR, BOR, RESET Instruction, $\overline{\text{MCLR}}$, WDT, Illegal Opcode, REPEAT Instruction, Hardware Traps, Configuration Word Mismatch (PWRT, OST, PLL Lock)			
Instruction Set	76 Base Instructions, Multiple Addressing Mode Variations			
Packages	44-Pin QFN/TQFP, 48-Pin UQFN		28-Pin SPDIP/SSOP/SOIC/QFN	

FIGURE 1-1: PIC24FXXXXX FAMILY GENERAL BLOCK DIAGRAMS



Note 1: All pins or features are not implemented on all device pinout configurations. See Table 1-5 for I/O port pin descriptions.

TABLE 1-5: PIC24FV16KM204 FAMILY PINOUT DESCRIPTION (CONTINUED)

Function	F					FV					I/O	Buffer	Description
	Pin Number					Pin Number							
	20-Pin PDIP/ SSOP/ SOIC	28-Pin PDIP/ SSOP/ SOIC	28-Pin QFN	44-Pin QFN/ TQFP	48-Pin UQFN	20-Pin PDIP/ SSOP/ SOIC	28-Pin PDIP/ SSOP/ SOIC	28-Pin QFN	44-Pin QFN/ TQFP	48-Pin UQFN			
OSCI	7	9	6	30	33	7	9	6	30	33	I	ANA	Primary Oscillator Input
OSCO	8	10	7	31	34	8	10	7	31	34	O	ANA	Primary Oscillator Output
PGEC1	5	5	2	22	24	5	5	2	22	24	I/O	ST	ICSP Clock 1
PGED1	4	4	1	21	23	4	4	1	21	23	I/O	ST	ICSP Data 1
PGEC2	2	22	19	9	10	2	22	19	9	10	I/O	ST	ICSP Clock 2
PGED2	3	21	18	8	9	3	21	18	8	9	I/O	ST	ICSP Data 2
PGEC3	10	15	12	42	46	10	15	12	42	46	I/O	ST	ICSP Clock 3
PGED3	9	14	11	41	45	9	14	11	41	45	I/O	ST	ICSP Data 3
PWRLCLK	10	12	9	34	37	10	12	9	34	37	I	ST	RTCC Power Line Clock Input
RA0	2	2	27	19	21	2	2	27	19	21	I/O	ST	PORTA Pins
RA1	3	3	28	20	22	3	3	28	20	22	I/O	ST	PORTA Pins
RA2	7	9	6	30	33	7	9	6	30	33	I/O	ST	PORTA Pins
RA3	8	10	7	31	34	8	10	7	31	34	I/O	ST	PORTA Pins
RA4	10	12	9	34	37	10	12	9	34	37	I/O	ST	PORTA Pins
RA5	1	1	26	18	19	1	1	26	18	19	I/O	ST	PORTA Pins
RA6	14	20	17	7	7	—	—	—	—	—	I/O	ST	PORTA Pins
RA7	—	19	16	6	6	—	19	16	6	6	I/O	ST	PORTA Pins
RA8	—	—	—	32	35	—	—	—	32	35	I/O	ST	PORTA Pins
RA9	—	—	—	35	38	—	—	—	35	38	I/O	ST	PORTA Pins
RA10	—	—	—	12	13	—	—	—	12	13	I/O	ST	PORTA Pins
RA11	—	—	—	13	14	—	—	—	13	14	I/O	ST	PORTA Pins
RB0	4	4	1	21	23	4	4	1	21	23	I/O	ST	PORTB Pins
RB1	5	5	2	22	24	5	5	2	22	24	I/O	ST	PORTB Pins
RB2	6	6	3	23	25	6	6	3	23	25	I/O	ST	PORTB Pins
RB3	—	7	4	24	26	—	7	4	24	26	I/O	ST	PORTB Pins
RB4	9	11	8	33	36	9	11	8	33	36	I/O	ST	PORTB Pins
RB5	—	14	11	41	45	—	14	11	41	45	I/O	ST	PORTB Pins
RB6	—	15	12	42	46	—	15	12	42	46	I/O	ST	PORTB Pins
RB7	11	16	13	43	47	11	16	13	43	47	I/O	ST	PORTB Pins
RB8	12	17	14	44	48	12	17	14	44	48	I/O	ST	PORTB Pins

Legend: ANA = Analog level input/output, ST = Schmitt Trigger input buffer, I^2C™ = I^2C/SMBus input buffer

TABLE 1-5: PIC24FV16KM204 FAMILY PINOUT DESCRIPTION (CONTINUED)

Function	F					FV					I/O	Buffer	Description
	Pin Number					Pin Number							
	20-Pin PDIP/ SSOP/ SOIC	28-Pin PDIP/ SSOP/ SOIC	28-Pin QFN	44-Pin QFN/ TQFP	48-Pin UQFN	20-Pin PDIP/ SSOP/ SOIC	28-Pin PDIP/ SSOP/ SOIC	28-Pin QFN	44-Pin QFN/ TQFP	48-Pin UQFN			
RB9	13	18	15	1	1	13	18	15	1	1	I/O	ST	PORTB Pins
RB10	—	21	18	8	9	—	21	18	8	9	I/O	ST	PORTB Pins
RB11	—	22	19	9	10	—	22	19	9	10	I/O	ST	PORTB Pins
RB12	15	23	20	10	11	15	23	20	10	11	I/O	ST	PORTB Pins
RB13	16	24	21	11	12	16	24	21	11	12	I/O	ST	PORTB Pins
RB14	17	25	22	14	15	17	25	22	14	15	I/O	ST	PORTB Pins
RB15	18	26	23	15	16	18	26	23	15	16	I/O	ST	PORTB Pins
RC0	—	—	—	25	27	—	—	—	25	27	I/O	ST	PORTC Pins
RC1	—	—	—	26	28	—	—	—	26	28	I/O	ST	PORTC Pins
RC2	—	—	—	27	29	—	—	—	27	29	I/O	ST	PORTC Pins
RC3	—	—	—	36	39	—	—	—	36	39	I/O	ST	PORTC Pins
RC4	—	—	—	37	40	—	—	—	37	40	I/O	ST	PORTC Pins
RC5	—	—	—	38	41	—	—	—	38	41	I/O	ST	PORTC Pins
RC6	—	—	—	2	2	—	—	—	2	2	I/O	ST	PORTC Pins
RC7	—	—	—	3	3	—	—	—	3	3	I/O	ST	PORTC Pins
RC8	—	—	—	4	4	—	—	—	4	4	I/O	ST	PORTC Pins
RC9	—	—	—	5	5	—	—	—	5	5	I/O	ST	PORTC Pins
REFO	18	26	23	15	16	18	26	23	15	16	O	—	Reference Clock Output
RTCC	—	25	22	14	15	—	25	22	14	15	O	—	Real-Time Clock/Calendar Output
SCK1	15	22	19	9	10	15	22	19	9	10	I/O	ST	MSSP1 SPI Clock
SDI1	17	21	18	8	9	17	21	18	8	9	I	ST	MSSP1 SPI Data Input
SDO1	16	24	21	11	12	16	24	21	11	12	O	—	MSSP1 SPI Data Output
$\overline{SS1}$	18	26	23	15	16	18	26	23	15	16	I	ST	MSSP1 SPI Slave Select Input
SCK2	—	14	11	38	41	—	14	11	38	41	I/O	ST	MSSP2 SPI Clock
SDI2	—	19	16	36	39	—	19	16	36	39	I	ST	MSSP2 SPI Data Input
SDO2	—	15	12	37	40	—	15	12	37	40	O	—	MSSP2 SPI Data Output
$\overline{SS2}$	—	23	20	35	38	—	23	20	35	38	I	ST	MSSP2 SPI Slave Select Input

Legend: ANA = Analog level input/output, ST = Schmitt Trigger input buffer, I^2C™ = I^2C/SMBus input buffer

TABLE 4-3: CPU CORE REGISTERS MAP

File Name	Addr.	Bit 15	Bit 14	Bit 13	Bit 12	Bit 11	Bit 10	Bit 9	Bit 8	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	All Resets
WREG0	0h	WREG0																0000
WREG1	2h	WREG1																0000
WREG2	4h	WREG2																0000
WREG3	6h	WREG3																0000
WREG4	8h	WREG4																0000
WREG5	Ah	WREG5																0000
WREG6	Ch	WREG6																0000
WREG7	Eh	WREG7																0000
WREG8	10h	WREG8																0000
WREG9	12h	WREG9																0000
WREG10	14h	WREG10																0000
WREG11	16h	WREG11																0000
WREG12	18h	WREG12																0000
WREG13	1Ah	WREG13																0000
WREG14	1Ch	WREG14																0000
WREG15	1Eh	WREG15																0800
SPLIM	20h	SPLIM Register																xxxx
PCL	2Eh	PCL Register																0000
PCH	30h	—	—	—	—	—	—	—	—	PCH7	PCH6	PCH5	PCH4	PCH3	PCH2	PCH1	PCH0	0000
TBLPAG	32h	—	—	—	—	—	—	—	—	TBLPAG7	TBLPAG6	TBLPAG5	TBLPAG4	TBLPAG3	TBLPAG2	TBLPAG1	TBLPAG0	0000
PSVPAG	34h	—	—	—	—	—	—	—	—	PSVPAG7	PSVPAG6	PSVPAG5	PSVPAG4	PSVPAG3	PSVPAG2	PSVPAG1	PSVPAG0	0000
RCOUNT	36h	RCOUNT Register																xxxx
SR	42h	—	—	—	—	—	—	—	DC	IPL2	IPL1	IPL0	RA	N	OV	Z	C	0000
CORCON	44h	—	—	—	—	—	—	—	—	—	—	—	—	IPL3	PSV	—	—	0000
DISICNT	52h	—	—	DISICNT13	DISICNT12	DISICNT11	DISICNT10	DISICNT9	DISICNT8	DISICNT7	DISICNT6	DISICNT5	DISICNT4	DISICNT3	DISICNT2	DISICNT1	DISICNT0	xxxx

Legend: x = unknown, u = unchanged, — = unimplemented, q = value depends on condition, r = reserved.

TABLE 4-8: MCCP1 REGISTER MAP

File Name	Addr.	Bit 15	Bit 14	Bit 13	Bit 12	Bit 11	Bit 10	Bit 9	Bit 8	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	All Resets
CCP1CON1L	140h	CCPON	—	CCPSIDL	r	TMRSYNC	CLKSEL2	CLKSEL1	CLKSEL0	TMRPS1	TMRPS0	T32	CCSEL	MOD3	MOD2	MOD1	MOD0	0000
CCP1CON1H	142h	OPSSRC	RTRGEN	—	—	OPS3	OPS2	OPS1	OPS0	TRIGEN	ONESHOT	ALTSYNC	SYNC4	SYNC3	SYNC2	SYNC1	SYNC0	0000
CCP1CON2L	144h	PWMRSEN	ASDGM	—	SSDG	—	—	—	—	ASDG7	ASDG6	ASDG5	ASDG4	ASDG3	ASDG2	ASDG1	ASDG0	0000
CCP1CON2H	146h	OENSYNC	—	OCFEN	OCEEN	OCDEN	OCCEN	OCBEN	OCAEN	ICGSM1	ICGSM0	—	AUXOUT1	AUXOUT0	ICS2	ICS1	ICS0	0100
CCP1CON3L	148h	—	—	—	—	—	—	—	—	—		DT5	DT4	DT3	DT2	DT1	DT0	0000
CCP1CON3H	14Ah	OETRIG	OSCNT2	OSCNT1	OSCNT0	—	OUTM2	OUTM1	OUTM0	—	—	POLACE	POLBDF	PSSACE1	PSSACE0	PSSBDF1	PSSBDF0	0000
CCP1STATL	14Ch	—	—	—	—	—	—	—	—	CCPTRIG	TRSET	TRCLR	ASEVT	SCEVT	ICDIS	ICOV	ICBNE	0000
CCP1TMRL	150h	MCCP1 Time Base Register Low Word																0000
CCP1TMRH	152h	MCCP1 Time Base Register High Word																0000
CCP1PRL	154h	MCCP1 Time Base Period Register Low Word																FFFF
CCP1PRH	156h	MCCP1 Time Base Period Register High Word																FFFF
CCP1RAL	158h	Output Compare 1 Data Word A																0000
CCP1RBL	15Ch	Output Compare 1 Data Word B																0000
CCP1BUFL	160h	Input Capture 1 Data Buffer Low Word																0000
CCP1BUFH	162h	Input Capture 1 Data Buffer High Word																0000

Legend: x = unknown, u = unchanged, — = unimplemented, q = value depends on condition, r = reserved.

REGISTER 8-22: IPC3: INTERRUPT PRIORITY CONTROL REGISTER 3

U-0	R/W-1	R/W-0	R/W-0	U-0	U-0	U-0	U-0
—	NVMIP2	NVMIP1	NVMIP0	—	—	—	—
bit 15							bit 8

U-0	R/W-1	R/W-0	R/W-0	U-0	R/W-1	R/W-0	R/W-0
—	AD1IP2	AD1IP1	AD1IP0	—	U1TXIP2	U1TXIP1	U1TXIP0
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as ‘0’	
-n = Value at POR	‘1’ = Bit is set	‘0’ = Bit is cleared	x = Bit is unknown

bit 15 **Unimplemented:** Read as ‘0’

bit 14-12 **NVMIP<2:0>:** NVM Interrupt Priority bits
111 = Interrupt is Priority 7 (highest priority interrupt)
•
•
•
001 = Interrupt is Priority 1
000 = Interrupt source is disabled

bit 11-7 **Unimplemented:** Read as ‘0’

bit 6-4 **AD1IP<2:0>:** A/D Conversion Complete Interrupt Priority bits
111 = Interrupt is Priority 7 (highest priority interrupt)
•
•
•
001 = Interrupt is Priority 1
000 = Interrupt source is disabled

bit 3 **Unimplemented:** Read as ‘0’

bit 2-0 **U1TXIP<2:0>:** UART1 Transmitter Interrupt Priority bits
111 = Interrupt is Priority 7 (highest priority interrupt)
•
•
•
001 = Interrupt is Priority 1
000 = Interrupt source is disabled

9.0 OSCILLATOR CONFIGURATION

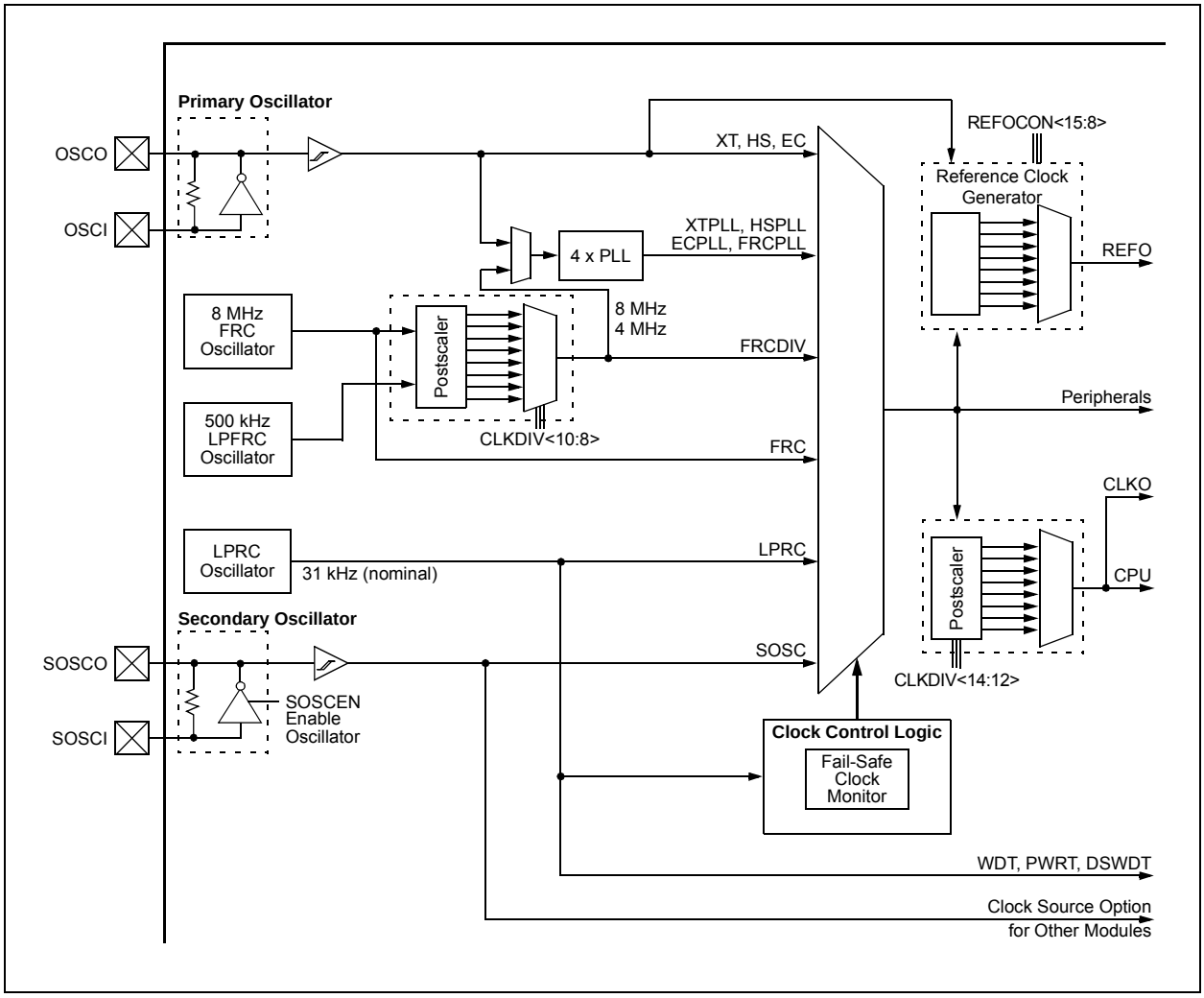
Note: This data sheet summarizes the features of this group of PIC24F devices. It is not intended to be a comprehensive reference source. For more information on oscillator configuration, refer to the *"PIC24F Family Reference Manual"*, **"Oscillator with 500 kHz Low-Power FRC"** (DS39726).

The oscillator system for the PIC24FV16KM204 family of devices has the following features:

- A total of five external and internal oscillator options as clock sources, providing 11 different clock modes.
- On-chip 4x Phase Locked Loop (PLL) to boost internal operating frequency on select internal and external oscillator sources.
- Software-controllable switching between various clock sources.
- Software-controllable postscaler for selective clocking of CPU for system power savings.
- System frequency range declaration bits for External Clock (EC) mode. When using an EC source, the current consumption is reduced by setting the declaration bits to the expected frequency range.
- A Fail-Safe Clock Monitor (FSCM) that detects clock failure and permits safe application recovery or shutdown.

A simplified diagram of the oscillator system is shown in Figure 9-1.

FIGURE 9-1: PIC24FXXXXX FAMILY CLOCK DIAGRAM



12.0 TIMER1

Note:	This data sheet summarizes the features of this group of PIC24F devices. It is not intended to be a comprehensive reference source. For more information on timers, refer to the *"PIC24F Family Reference Manual"*, **"Timers"** (DS39704).

The Timer1 module is a 16-bit timer which can serve as the time counter for the Real-Time Clock (RTC) or operate as a free-running, interval timer/counter. Timer1 can operate in three modes:

- 16-Bit Timer
- 16-Bit Synchronous Counter
- 16-Bit Asynchronous Counter

Timer1 also supports these features:

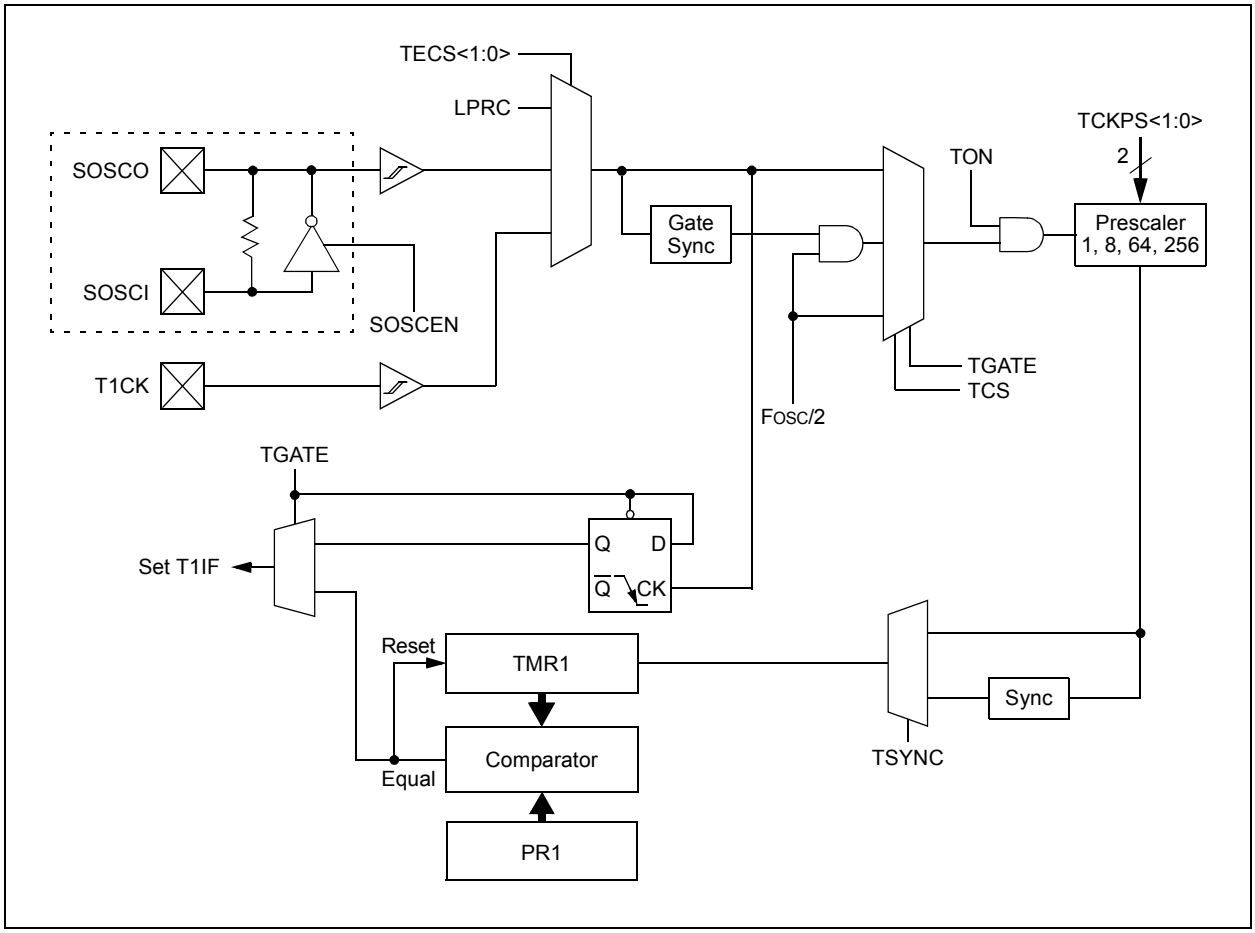
- Timer Gate Operation
- Selectable Prescaler Settings
- Timer Operation During CPU Idle and Sleep modes
- Interrupt on 16-Bit Period Register Match or Falling Edge of External Gate Signal

Figure 12-1 illustrates a block diagram of the 16-bit Timer1 module.

To configure Timer1 for operation:

1. Set the TON bit (= 1).
2. Select the timer prescaler ratio using the TCKPS<1:0> bits.
3. Set the Clock and Gating modes using the TCS and TGATE bits.
4. Set or clear the TSYNC bit to configure synchronous or asynchronous operation.
5. Load the timer period value into the PR1 register.
6. If interrupts are required, set the Timer1 Interrupt Enable bit, T1IE. Use the Timer1 Interrupt Priority bits, T1IP<2:0>, to set the interrupt priority.

FIGURE 12-1: 16-BIT TIMER1 MODULE BLOCK DIAGRAM



REGISTER 12-1: T1CON: TIMER1 CONTROL REGISTER

R/W-0	U-0	R/W-0	U-0	U-0	U-0	R/W-0	R/W-0
TON	—	TSIDL	—	—	—	TECS1(1)	TECS0(1)
bit 15							bit 8

U-0	R/W-0	R/W-0	R/W-0	U-0	R/W-0	R/W-0	U-0
—	TGATE	TCKPS1	TCKPS0	—	TSYNC	TCS	—
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 15 **TON:** Timer1 On bit
1 = Starts 16-bit Timer1
0 = Stops 16-bit Timer1

bit 14 **Unimplemented:** Read as '0'

bit 13 **TSIDL:** Timer1 Stop in Idle Mode bit
1 = Discontinues module operation when device enters Idle mode
0 = Continues module operation in Idle mode

bit 12-10 **Unimplemented:** Read as '0'

bit 9-8 **TECS<1:0>:** Timer1 Extended Clock Select bits(1)
11 = Reserved; do not use
10 = Timer1 uses the LPRC as the clock source
01 = Timer1 uses the External Clock (EC) from T1CK
00 = Timer1 uses the Secondary Oscillator (SOSC) as the clock source

bit 7 **Unimplemented:** Read as '0'

bit 6 **TGATE:** Timer1 Gated Time Accumulation Enable bit
When TCS = 1:
This bit is ignored.
When TCS = 0:
1 = Gated time accumulation is enabled
0 = Gated time accumulation is disabled

bit 5-4 **TCKPS<1:0>:** Timer1 Input Clock Prescale Select bits
11 = 1:256
10 = 1:64
01 = 1:8
00 = 1:1

bit 3 **Unimplemented:** Read as '0'

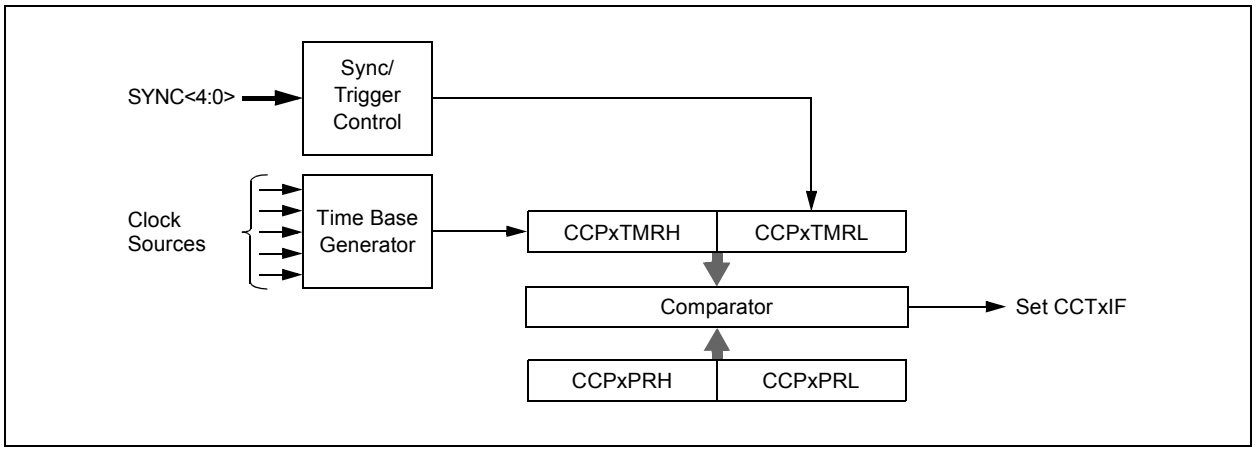
bit 2 **TSYNC:** Timer1 External Clock Input Synchronization Select bit
When TCS = 1:
1 = Synchronizes External Clock input
0 = Does not synchronize External Clock input
When TCS = 0:
This bit is ignored.

bit 1 **TCS:** Timer1 Clock Source Select bit
1 = Timer1 clock source is selected by TECS<1:0>
0 = Internal clock (FOSC/2)

bit 0 **Unimplemented:** Read as '0'

Note 1: The TECSx bits are valid only when TCS = 1.

FIGURE 13-4: 32-BIT TIMER MODE



REGISTER 13-7: CCPxSTATL: CCPx STATUS REGISTER

U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
—	—	—	—	—	—	—	—
bit 15							bit 8

R-0	W1-0	W1-0	R/C-0	R/C-0	R/C-0	R/C-0	R/C-0
CCPTRIG	TRSET	TRCLR	ASEVT	SCEVT	ICDIS	ICOV	ICBNE
bit 7							bit 0

Legend:	C = Clearable bit		
R = Readable bit	W1 = Write ‘1’ only	U = Unimplemented bit, read as ‘0’	
-n = Value at POR	‘1’ = Bit is set	‘0’ = Bit is cleared	x = Bit is unknown

bit 15-8 **Unimplemented:** Read as ‘0’

bit 7 **CCPTRIG:** CCPx Trigger Status bit
1 = Timer has been triggered and is running
0 = Timer has not been triggered and is held in Reset

bit 6 **TRSET:** CCPx Trigger Set Request bit
Write ‘1’ to this location to trigger the timer when TRIGEN = 1 (location always reads as ‘0’).

bit 5 **TRCLR:** CCPx Trigger Clear Request bit
Write ‘1’ to this location to cancel the timer Trigger when TRIGEN = 1 (location always reads as ‘0’).

bit 4 **ASEVT:** CCPx Auto-Shutdown Event Status/Control bit
1 = A shutdown event is in progress; CCPx outputs are in the shutdown state
0 = CCPx outputs operate normally

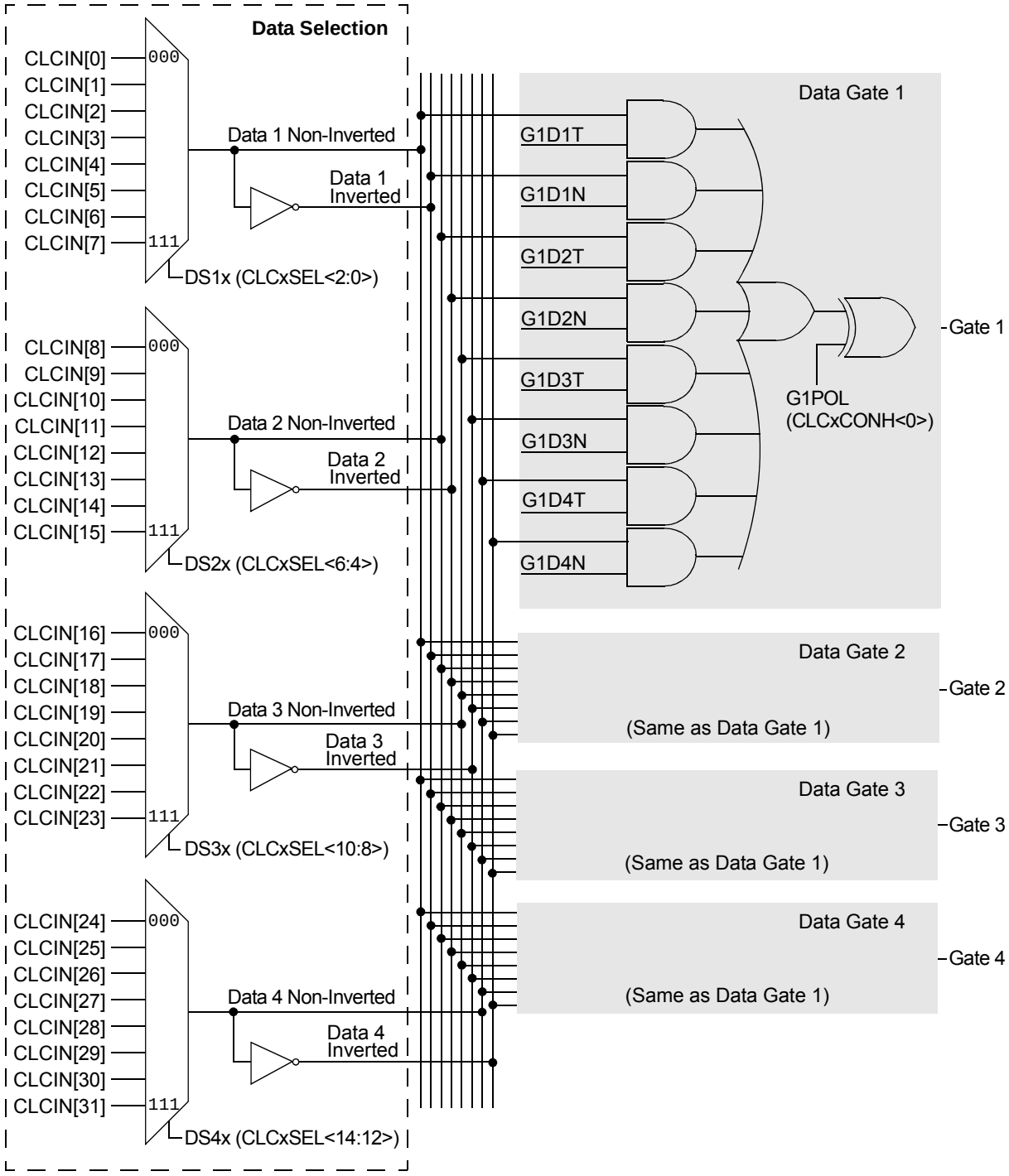
bit 3 **SCEVT:** Single Edge Compare Event Status bit
1 = A single edge compare event has occurred
0 = A single edge compare event has not occurred

bit 2 **ICDIS:** Input Capture x Disable bit
1 = Event on Input Capture x pin (ICx) does not generate a capture event
0 = Event on Input Capture x pin will generate a capture event

bit 1 **ICOV:** Input Capture x Buffer Overflow Status bit
1 = The Input Capture x FIFO buffer has overflowed
0 = The Input Capture x FIFO buffer has not overflowed

bit 0 **ICBNE:** Input Capture x Buffer Status bit
1 = Input Capture x buffer has data available
0 = Input Capture x buffer is empty

FIGURE 17-3: CLCx INPUT SOURCE SELECTION DIAGRAM



Note: All controls are undefined at power-up.

19.2 A/D Sampling Requirements

The analog input model of the 12-bit A/D Converter is shown in Figure 19-2. The total sampling time for the A/D is a function of the holding capacitor charge time.

For the A/D Converter to meet its specified accuracy, the Charge Holding Capacitor (CHOLD) must be allowed to fully charge to the voltage level on the analog input pin. The Source Impedance (RS), the Interconnect Impedance (RIC) and the Internal Sampling Switch Impedance (RSS) combine to directly affect the time required to charge CHOLD. The combined impedance of the analog sources must, therefore, be small enough to fully charge the holding capacitor within the chosen sample time. To minimize the effects of pin leakage currents on the accuracy of the A/D Converter, the maximum recommended source impedance, RS, is 2.5 kΩ. After the analog input channel is selected (changed), this sampling function must be completed prior to starting the conversion. The internal holding capacitor will be in a discharged state prior to each sample operation.

At least 1 TAD time period should be allowed between conversions for the sample time. For more details, see **Section 27.0 "Electrical Characteristics"**.

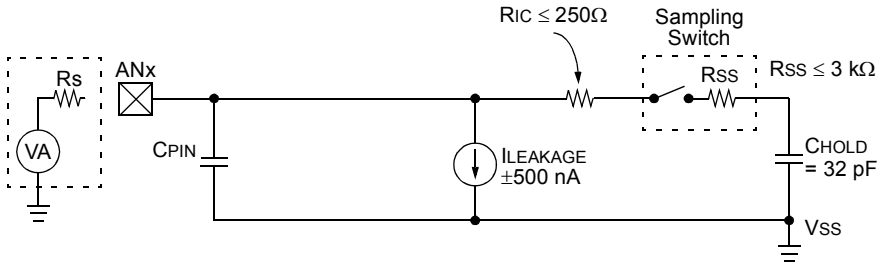
EQUATION 19-1: A/D CONVERSION CLOCK PERIOD

$$TAD = TCY\ (ADCS + 1)$$

$$ADCS = \frac{TAD}{TCY} - 1$$

Note: Based on TCY = 2/FOSC; Doze mode and PLL are disabled.

FIGURE 19-2: 12-BIT A/D CONVERTER ANALOG INPUT MODEL



Legend: CPIN = Input Capacitance
VT = Threshold Voltage
ILEAKAGE = Leakage Current at the Pin Due to Various Junctions
RIC = Interconnect Resistance
RSS = Sampling Switch Resistance
CHOLD = Sample-and-Hold Capacitance (from DAC)

Note: The CPIN value depends on the device package and is not tested. The effect of CPIN is negligible if Rs ≤ 5 kΩ.

TABLE 27-21: PLL CLOCK TIMING SPECIFICATIONS

AC CHARACTERISTICS			Standard Operating Conditions: 1.8V to 3.6V (PIC24F16KM204) 2.0V to 5.5V (PIC24FV16KM204) Operating temperature -40°C ≤ TA ≤ +85°C for Industrial -40°C ≤ TA ≤ +125°C for Extended				
Param No.	**Sym**	**Characteristic(1)**	**Min**	**Typ(2)**	**Max**	**Units**	**Conditions**
OS50	FPLLI	PLL Input Frequency Range	4	—	8	MHz	ECPLL, HSPLL modes, -40°C ≤ TA ≤ +85°C
OS51	FSYS	PLL Output Frequency Range	16	—	32	MHz	-40°C ≤ TA ≤ +85°C
OS52	TLOCK	PLL Start-up Time (Lock Time)	—	1	2	ms	
OS53	DCLK	CLKO Stability (Jitter)	-2	1	2	%	Measured over 100 ms period

Note 1: These parameters are characterized but not tested in manufacturing.

2: Data in "Typ" column is at 3.3V, +25°C unless otherwise stated. Parameters are for design guidance only and are not tested.

TABLE 27-22: INTERNAL RC OSCILLATOR ACCURACY

AC CHARACTERISTICS		Standard Operating Conditions: 1.8V to 3.6V (PIC24F16KM204) 2.0V to 5.5V (PIC24FV16KM204) Operating temperature -40°C ≤ TA ≤ +85°C for Industrial -40°C ≤ TA ≤ +125°C for Extended					
Param No.	**Characteristic**	**Min**	**Typ**	**Max**	**Units**	**Conditions**	
F20	FRC @ 8 MHz(1)	-2	—	+2	%	+25°C	3.0V ≤ VDD ≤ 3.6V, F device 3.2V ≤ VDD ≤ 5.5V, FV device
		-5	—	+5	%	-40°C ≤ TA ≤ +125°C	1.8V ≤ VDD ≤ 3.6V, F device 2.0V ≤ VDD ≤ 5.5V, FV device
F21	LPRC @ 31 kHz(2)	-15	—	+15	%	-40°C ≤ TA ≤ +125°C	1.8V ≤ VDD ≤ 3.6V, F device 2.0V ≤ VDD ≤ 5.5V, FV device

Note 1: The frequency is calibrated at +25°C and 3.3V. The OSCTUN bits can be used to compensate for temperature drift.

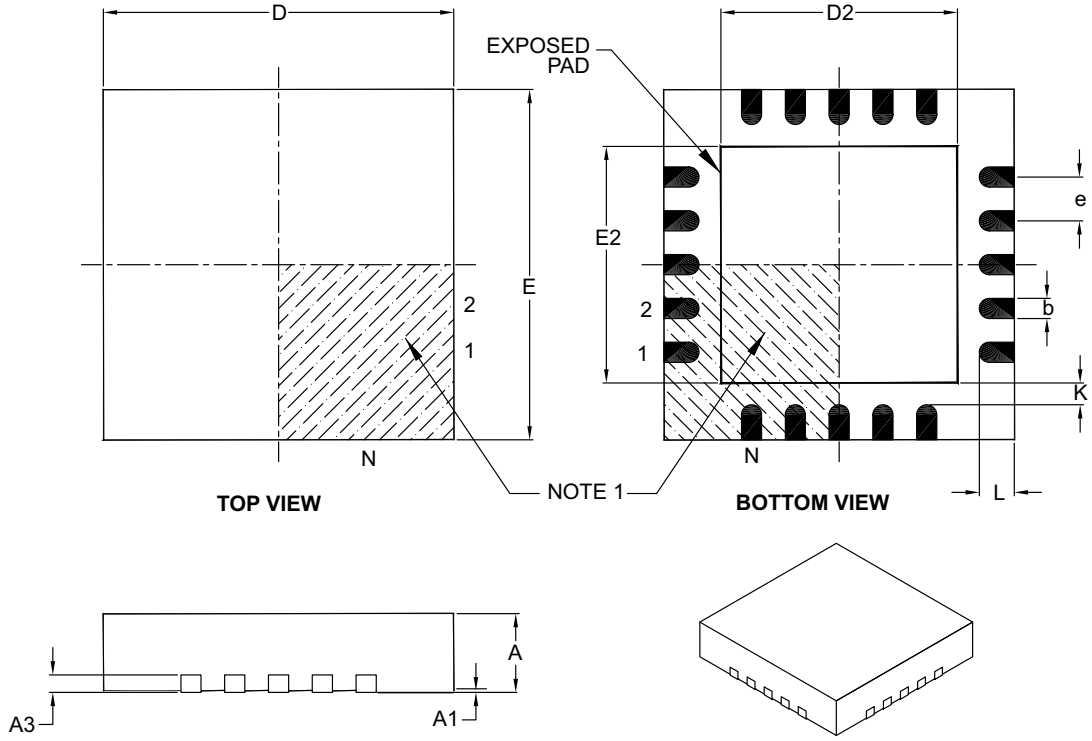
2: The change of LPRC frequency as VDD changes.

TABLE 27-23: INTERNAL RC OSCILLATOR SPECIFICATIONS

AC CHARACTERISTICS			Standard Operating Conditions: 1.8V to 3.6V (PIC24F16KM204) 2.0V to 5.5V (PIC24FV16KM204) Operating temperature -40°C ≤ TA ≤ +85°C for Industrial -40°C ≤ TA ≤ +125°C for Extended				
Param No.	**Sym**	**Characteristic**	**Min**	**Typ**	**Max**	**Units**	**Conditions**
	TFRC	FRC Start-up Time	—	5	—	μs	
	TLPRC	LPRC Start-up Time	—	70	—	μs	

20-Lead Plastic Quad Flat, No Lead Package (ML) – 4x4x0.9 mm Body [QFN]

Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



Units		MILLIMETERS		
Dimension Limits		MIN	NOM	MAX
Number of Pins	N		20	
Pitch	e		0.50 BSC	
Overall Height	A	0.80	0.90	1.00
Standoff	A1	0.00	0.02	0.05
Contact Thickness	A3		0.20 REF	
Overall Width	E		4.00 BSC	
Exposed Pad Width	E2	2.60	2.70	2.80
Overall Length	D		4.00 BSC	
Exposed Pad Length	D2	2.60	2.70	2.80
Contact Width	b	0.18	0.25	0.30
Contact Length	L	0.30	0.40	0.50
Contact-to-Exposed Pad	K	0.20	–	–

Notes:

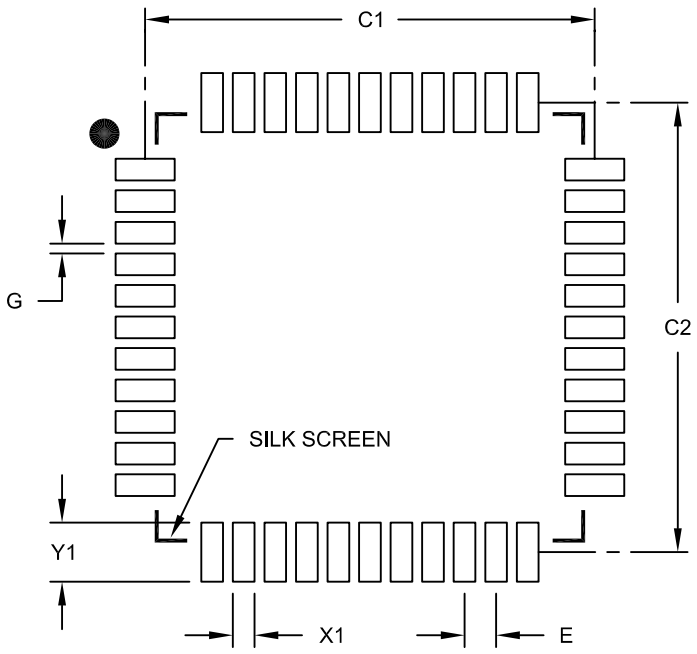
1. Pin 1 visual index feature may vary, but must be located within the hatched area.
2. Package is saw singulated.
3. Dimensioning and tolerancing per ASME Y14.5M.

BSC: Basic Dimension. Theoretically exact value shown without tolerances.
REF: Reference Dimension, usually without tolerance, for information purposes only.

Microchip Technology Drawing C04-126B

44-Lead Plastic Thin Quad Flatpack (PT) 10X10X1 mm Body, 2.00 mm Footprint [TQFP]

Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



RECOMMENDED LAND PATTERN

Units		MILLIMETERS		
Dimension Limits		MIN	NOM	MAX
Contact Pitch	E		0.80 BSC	
Contact Pad Spacing	C1		11.40	
Contact Pad Spacing	C2		11.40	
Contact Pad Width (X44)	X1			0.55
Contact Pad Length (X44)	Y1			1.50
Distance Between Pads	G	0.25		

Notes:

1. Dimensioning and tolerancing per ASME Y14.5M

BSC: Basic Dimension. Theoretically exact value shown without tolerances.

Microchip Technology Drawing No. C04-2076B

NOTES:

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